

# ESTC<sub>2006</sub> - The European One

1<sup>st</sup> Electronics Systemintegration Technology Conference



den (Germany). As a result of the ESTC program chairs meeting in October we present you the complete Executive and Program Committee List on our website: **141.30.122.65**. Excellent engineers and scientists from all over the world are ready to review your abstracts.

Please be aware the abstracts deadline is **February 15th, 2006!**

**141.30.122.65**

The 2nd Call for Papers is available now: [141.30.122.65/DOCS/Second-Call-Web.pdf](http://141.30.122.65/DOCS/Second-Call-Web.pdf)

KEYNOTE SPEAKERS: (preliminary list)

**Systemintegration:** **Herbert Reichl**, Director of the Fraunhofer Institute for Reliability and Microintegration, Fraunhofer IZM Berlin, Germany

**Reliability:** **Katsuaki Suganuma**, Head of the Department of Nanomaterials and Environmentally Conscious Technology, The Institute of Scientific and Industrial Research, Osaka University, Japan

**Automotive:** **Steve Prosser**, Chief Engineer – Technology, Electronic Control Systems, TRW Automotive, Solihull, UK

**Semiconductor:** **Ralf Plieninger**, Senior Director Technology, Assembly and Test, Communications Group, Infineon Technologies AG, Regensburg, Germany

**Avionics:** **Robert M. Newman**, Technology Consultant Electronic Packaging, Goodrich Engine Control systems, Birmingham, UK

Special Paper Recognition

**Best Paper Award:** ESTC will select the best paper whose author(s) will receive an award and share a check for EUR 1.000,-.

**Best Poster Award:** ESTC will select the best poster whose author(s) will receive an award and share a check for EUR 1.000,-.

**High quality level papers** will be published after the conference based on a peer review process in different IEEE Transactions.



## ICT-2006

### The 25<sup>th</sup> International Conference on Thermoelectrics

University of Vienna  
Vienna, Austria, Europe  
August 6-10, 2006



### First Announcement

This 25th International Conference on Thermoelectrics (ICT 2006) will examine a spectrum of plenary, invited and contributed presentations to provide an overview of the status of research and development in thermoelectric materials, devices and applications. Recent activity in this field will highlight a combination of new ideas, materials and device concepts in Europe, the USA and Asia. Recent energy issues will make this a timely conference and should be an excellent forum to assess the current status and future of the field of thermoelectrics.

#### Organization of ICT'06

Conference Chairman  
**Univ. Prof. Peter Rogl**  
University of Vienna  
[peter.franz.rogl@univie.ac.at](mailto:peter.franz.rogl@univie.ac.at)

Secretariat of ICT-2006  
**Dr. Andriy Grytsiv**  
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**For more information or to submit an abstract:**

[www.univie.ac.at/ICT06](http://www.univie.ac.at/ICT06)

Conference e-mail address:  
[am.physchemie@univie.ac.at](mailto:am.physchemie@univie.ac.at)

**Past Proceedings from ICT:**

[www.cpmt.org/proceedings/order.html](http://www.cpmt.org/proceedings/order.html)

Papers also available online: [ieeexplore.ieee.org](http://ieeexplore.ieee.org)  
Search for "thermoelectric"